

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Applicants:

Date: March 14, 2002

Beaman et al.

Group Art Unit: 2858

Serial No.: 09/382,834

Examiner: V. Nguyen

Filed: August 25, 1999

Docket No.: YO993-028BX

For: HIGH DENSITY INTEGRATED CIRCUIT APPARATUS,
TEST PROBE AND METHODS OF USE THEREOFAssistant Commissioner for Patents
Washington, D. C. 20231(N.E.)
17/Response
J. Steptay
3-18-02

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this Amendment is being facsimile transmitted under Rule 37 CFR 1.61(d) to the U.S. Patent and Trademark Office to (703) 308-7382 on March 14, 2002.

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Reg. No. 32,053

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MAR 14 2002

AMENDMENT AFTER FINAL

TECHNOLOGY CENTER 28:

In response to Office Action dated October 5, 2001, please consider the following:

REMARKS

Reconsideration is respectfully requested in view of any changes to the claims and the remarks herein.

Claim 37 has been rejected under 35 USC 102(b) as anticipated by Bove et al. Applicants request the Examiner to identify wherein the limitation of claim 37 is found in Bove et al., in particular where does Bove et al. teach "shaped wires". Bove et al. teaches only straight wires and thus cannot anticipate claim 37.

Please charge any fee necessary to enter this paper and any previous paper to deposit account 09-0468.

Respectfully submitted,

By

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